

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Kimio TAKEUCHI</td><td>05/14/2007</td></tr><tr><td>Takahiro KUROSAWA</td><td>05/14/2007</td></tr><tr><td>Kentaro ICHIKAWA</td><td>05/14/2007</td></tr><tr><td>Norihisa HIROTA</td><td>05/14/2007</td></tr></tbody></table>	Name	Execution Date	Kimio TAKEUCHI	05/14/2007	Takahiro KUROSAWA	05/14/2007	Kentaro ICHIKAWA	05/14/2007	Norihisa HIROTA	05/14/2007	
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Kimio TAKEUCHI	05/14/2007										
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Kentaro ICHIKAWA	05/14/2007										
Norihisa HIROTA	05/14/2007										
RECEIVING PARTY DATA											
Name:	TOYO SEIKAN KAISHA, LTD.										
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City:	Tokyo										
State/Country:	JAPAN										
Postal Code:	100-8522										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11814453</td></tr></tbody></table>	Property Type	Number	Application Number:	11814453							
Property Type	Number										
Application Number:	11814453										
CORRESPONDENCE DATA											
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NAME OF SUBMITTER:	Scott M. Daniels										
Total Attachments: 1											

OP \$40.00 11814453

500325171

PATENT
REEL: 019625 FRAME: 0487

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

(Insert ASSIGNEE's
Name(s) Address(es))

TOYO SEIKAN KAISHA, LTD.

3-1, Uchisaiwaicho 1-chome, Chiyoda-ku, Tokyo 100-8522 JAPAN

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

**METHOD AND DEVICE FOR FEEDING MOLTEN RESIN, AND
METHOD FOR MANUFACTURING MOLDED ARTICLE BY
USING THE FED MOLTEN RESIN**

(*If the assignment is
being filed after the
filing of the
application, this
section must be
completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

* filed on _____ Serial No. _____

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

<u>Kimio Takeuchi</u> (Signature)	<u>Kimio TAKEUCHI</u> (Type Name)	<u>14 May 2007</u> (Date)
<u>Takahiro Kurosawa</u> (Signature)	<u>Takahiro KUROSAWA</u> (Type Name)	<u>14 May 2007</u> (Date)
<u>Kentaro Ichikawa</u> (Signature)	<u>Kentaro ICHIKAWA</u> (Type Name)	<u>14 May 2007</u> (Date)
<u>Norihisa Hirota</u> (Signature)	<u>Norihisa HIROTA</u> (Type Name)	<u>14 May 2007</u> (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)

NO LEGALIZATION REQUIRED

PATENT

RECORDED: 07/31/2007

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